Viper EBX Single Board Computer

Overview

The Viper is a low power / high-performance single board computer (SBC) which combines Intel's advanced Bay Trail processor, with a traditional PC/104-*Plus*[™] expansion interface. This combination makes it easy to upgrade existing systems to a powerful 4th generation Atom processor, while preserving plug-in expansion to existing specialty I/O boards. In addition, it also contains a full complement of on-board I/O interfaces, including USB 3.0, mini PCIe expansion socket, TPM chip, A/D, D/A, and 32-bits of digital I/O.

Driven by a low power E3800 (Bay Trail) processor, with clock rates up to 1.9 GHz, the Viper features quad-, dual-, and single-core processor options.

Viper is built on the industry-standard EBX form factor. It includes legacy ISA and PCI connectors to interface directly with PC/104-*Plus* expansion boards.

As with all VersaLogic products, the Viper is designed to support OEM applications where high reliability and long-term availability are required. Viper is backed by a 5-year warranty, 5-year minimum off-the-shelf availability guarantee, and expert US-based technical support. From application design-in support, to its 10+ year extended life programs, the Viper provides a durable embedded computer solution with an excellent cost of ownership.

Highlights

- -40° to +85°C Operating Temperature
- Shock and vibration per MIL-STD-202G
- EBX[™] form factor
- PC/104-Plus expansion
- On board power conditioning.
 9 to 15 volt input
- Fanless versions
- 4th Generation Intel[®] Atom[™] processor ("Bay Trail") Quad-, dual-, and single-core models.
- TPM (Trusted Platform Module) security chip

- Up to 16 GB RAM
- Low power draw
 - Dual Gigabit Ethernet
 - VGA, DisplayPort, and LVDS video output
 - Mini PCIe expansion sockets
 - USB 3.0 and 2.0 ports
 - Serial I/O (RS-232/422/485)
 - I2C, SPI / SPX
 - Digital I/O (40 lines)
- Analog Input (8 chan.)
- Analog Output (4 chan.)
- VersaAPI software support



Features

1 Intel Atom "Bay Trail" Processor

Up to 1.9 GHz clock rate. Quad-, dual-, or single-core options. Low power consumption.

2 Trusted Platform Module

On-board TPM security chip can lock out unauthorized hardware and software access.

3 High-performance Video

Integrated Intel Gen 7 graphics core supports DirectX 11, OpenGL 4, and H.264, MPEG-2 encoding/ decoding. Analog (VGA) (3a), Mini DisplayPort (3b), and LVDS video outputs (3c). DisplayPort supports HD audio output.

4 Network

Dual Gigabit Ethernet (GbE) with remote boot support.

5 Memory

Up to two SO-DIMM sockets. Up to 8 or 16 GB DDR3L memory - model dependent. (**5a on front** and **5b on back**).

6 SATA

Dual 3 Gb/s SATA ports. Supports rotating or solid state SATA drives.

7 Mini PCIe Card Sockets

Dual full-sized sockets. Supports Wi-Fi modems, GPS, MIL-STD-1553, Ethernet, flash data storage, and other mini PCIe modules (**7a and 7b**).

8 MicroSD Socket

Supports removable microSD card solid-state drives.

Industrial I/O

One USB 3.0 port (9a) and six USB 2.0 ports (9b) support keyboard, mouse, and other devices. Three 8254 timer/counters, and I2C support.

Four RS-232/422/485 serial ports (9c).

10 Analog and Digital I/O

On-board data acquisition support. Eight analog inputs, four analog outputs (**10a**), and forty 3.3V digital I/O lines (**10b**).

1 SPI Interface

Supports SPI and SPX devices, including low cost analog and digital modules.

12 Power Input

Wide input 9 to 15V or regulated 5V. Jumper selectable.

13 PC/104-Plus Expansion

Legacy PCI and ISA connectors

Fanless Operation

No moving parts required for CPU cooling in most configurations.

Industrial Temperature Versions

-40° to +85°C operation for harsh environments.

MIL-STD-202G

Qualified for high shock and vibration environments.

Software Support

Compatible with a variety of popular x86 operating systems including Windows, Windows Embedded, Linux, and VxWorks.



Tailor Viper to Your Exact Requirements

Customization options are available in quantities as low as 100 pieces.

- Conformal Coating
- Custom Cabling
- Connector & I/O
- Changes
 Custom Testing
- Custom Labeling
- BGA Underfill
- BIOS Modifications
- Software and Drivers
- Revision Locks
- Custom Screening
- Application-Specific Testing
- And more –

Specifications

Board Size EBX standard: 146 x 203 mm (5.75 x 8") Processor Intel 4th Generation Atom E3845 (quad core), E3826 (dual core), or E3815 (single core). S12K L2 cache per core. Supports Intel 64-bit instructions, AES Instructions, Execute Disable Bit, and Virtualization Technology. Input Voltage 5V +/- 5% or wide input: 9 to 15V (12V nominal). Jumper selectable. Power Requirements Model Idle Typical Max. § EBX-38EAP 5.5W 6.0W 6.5W EBX-38ECP 6.0W 7.0W 8.0W EBX-38ECP 6.0W 7.0W 9.5W System Reset & Hardware Monitors All voltage rails monitored. Watchdog timer with programmable timeout. CPU temperature and fan speed monitoring. Push-button reset and power. Stackable Bus PC/104-Plus format. ISA and PCI connectors. RoHS RoHS (EU 2015/863) Environmental Ideat Sink Heat Sink Heat Sink Heat Sink with fan, heat pipe, and other adaptors available. Operating Model Heat Plate** Heat Sink with fan, heat pipe, and other adaptors available. Operating Model Heat Plate** Heat Sink Heat Si	General							
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System RAM VL-EBX-38EBP and VL-EBX-38ECP models support two SO-DIMM sockets, each socket supports up to 8 GB DDR3L (1.35V) SDRAM. Max memory 16 GB. VL-EBX-38EAP has one SO-DIMM socket, max memory up to 8 GB. Memory Speed	Memory							
SO-DIMM sockets, each socket supports up to 8 GB DDR3L (1.35V) SDRAM. Max memory 16 GB. VL-EBX-38EAP has one SO-DIMM socket, max memory up to 8 GB. Memory Speed 1066 MHz or 1333 MHz, CPU dependent	System RAM	VI-EBX-38EBP and VI-EBX-38ECP models support two						
Memory Speed 1066 MHz or 1333 MHz, CPU dependent		SO-DIMM sockets, each socket supports up to 8 GB DDR3L (1.35V) SDRAM. Max memory 16 GB. VL-EBX-38EAP has one SO-DIMM socket, max memory up to 8 GB						
	Memory Speed	1066 MHz or 1333 MHz, CPU dependent						

§ Represents operation at +25°C and +12V running Windows 7 with on-board, VGA display, SATA, Ethernet, COM, and USB keyboard/mouse. Typical power computed as the mean value of Idle and Maximum power specifications. Maximum power measured with 95% CPU utilization.

‡ TVS protected port (enhanced ESD protection)

Power pins are overload protected

Ø Derate -1.1°C per 305m (1,000 ft.) above 2,300m (7,500 ft.)

* For extended altitude information contact VersaLogic Sales.

IIL-STD-202G shock and vibration levels were used to illustrate the overall ruggedness of this product. Certification at higher levels or different types of shock or vibration methods per the specific requirements of the application is available. Contact VersaLogic Sales for further information.

Specifications are subject to change without notification. EBX and PC/104-*Plus* are trademarks of the PC/104 Consortium. All other trademarks are the property of their respective owners.

Video						
General	Integrated high-performance video. Intel Gen-7 graphics core with 4 Execution Units and Turbo Boost. Supports 2 independent displays. Supports DirectX 11, OpenGL 4.0, VP8, MPEG2, H.264, VC1, 2 HD streams (1080p@30fps), Flash and WMP support.					
	Hardware Based Format					
	Decode H.264, MPEG2,, MPEG4, MVC, VC-1, WMV9, VP8, MJPEG					
	Encode H.264, MPEG2, MVC					
	Analog and dual mini DisplayPort, and LVDS video interfaces support Extended Desktop, Clone, and Twin display modes.					
VRAM	Up to 224 MB shared DRAM					
Desktop Display Interface ‡	Standard analog output (VGA). 24-bit. Up to 1920 x 1080 (60 Hz).					
DisplayPort Interface ‡	Dual Mini DisplayPort outputs. One supports DP++ and HDMI signaling (Video and Audio outputs). 2nd Mini DisplayPort supports DP only (no Audio output). 24-bit. Up to 2560 x 1600.					
OEM Flat Panel Interface #	Single- or Dual-channel LVDS interface. Up to 1920 x 1200 18/24-bit.					
LVDS Panel Power	3.3V (1A max) supply for Panel.					
Mass Storage						
Rotating or Solid- State Drives	Dual SATA (Revision 2.0) ports. Latching connectors					
Flash storage	mSATA (mini-PCIe) socket (SATA signaling, bootable)					
Flash storage	MicroSD socket. Bootable					
Network Interface						
Ethernet ‡	Two autodetect 10BaseT/100BaseTX/1000BaseT ports with status LEDs. IEEE 1588 Precision Time Protocol (PTP) compatible.					
Network Boot Option	Via BIOS extension					
Device I/O						
USB # ‡	One USB 3.0 host port and six USB 2.0 host ports.					
СОМ	Four RS-232/422/485 selectable. 16C550 compatible. 460 Kbps.					
Analog Input	Eight 12-bit channels. Single-ended and/or differential. 100 Ksps. 0 to \pm 5V, \pm 5V, 0 to \pm 10V, and \pm 10V.					
Analog Output	Four channels. 12-bit single-ended. 100 Ksps. 0 to +4.096V.					
Digital I/O	Forty TTL I/O lines (3.3V). Independently configurable.					
Audio	Optional. Use VL-ADR-01 audio adapter.					
Counter/Timers	I nree 8254 16-bit timers					
Other I/O						
Mini PCle / mSATA Socket	Two full-size Mini PCIe sockets. One with mSATA signaling support. Supports Wi-Fi modems, GPS receivers, solid state mSATA drives, and other plug-in modules.					
SPI Interface	Supports SPI and SPX devices. Supports up to four SPX modules.					
Software						
BIOS	Phoenix Technologies UEFI BIOS. Field reprogrammable. Support for USB keyboard/mouse and USB boot.					
VersaAPI	VersaLogic Application Programming Interface to support on-board I/O devices.					
Sleep Mode	ACPI 3.0. Support for S3 and S4 suspend states and C1 processor state.					
Operating Systems	Compatible with most x86 operating systems including Windows, Windows Embedded, Linux, VxWorks, and QNX.					



Ordering Information

Model	Processor	Cores	Speed	Maximum Memory	DDR Max Speed	Graphics Frequency (Normal/Boost)	Operating Temp.	Cooling
VL-EBX-38EAP	Atom E3815	Single	1.46 GHz	8 GB	1066 MHz	400 MHz / none	-40° to +85°C	Heat plate
VL-EBX-38EBP	Atom E3826	Dual	1.46 GHz	16 GB	1066 MHz	533 MHz/ 667 MHz	-40° to +85°C	Heat plate
VL-EBX-38ECP	Atom E3845	Quad	1.91 GHz	16 GB	1333 MHz	542 MHz/ 792 MHz	-40° to +85°C	Heat plate

Other configurations are possible. Please contact VersaLogic Sales at (503) 747-2261 to discuss requirements!

Accessories

Part Number	Description			
Cable Kit				
VL-CKR-VIPER	evelopment Cable kit for EBX-38. Includes: EBX-38 Viper cable kit. Icludes VL-CBR-4005, 0702, 1014 x2, 1204, 2004, 2005 x2, 2022, IDW-401, and 105 x2.			
VL-CBR-4005	I/O Cable Assy, Cbl & Pdl Bd, RoHS			
VL-CBR-2022	ATX 5V (20-pin ATX) power adapter cable , 6.5"			
VL-CBR-2005 (x2)	1 mm 20-pin to 20-pin DIO Cable, RoHS, 12"			
VL-CBR-2004	1 mm 20-pin to 20-pin Analog Cable, RoHS, 12"			
VL-CBR-1204	VGA Interface Cable, 12-pin PicoClasp Cable to 15-pin VGA, 12"			
VL-CBR-0702	SATA cable – rugged latching, 20"			
VL-CBR-1014 (x2)	1 mm 10-pin Pico-Clasp to two DB-9 Cable, RoHS, 12"			
VL-HDW-105 (x2)	0.6" standoff package (metric thread)			
VL-HDW-401	Thermal compound paste. For attaching heat plates and sinks			
Thermal Options				
VL-HDW-406	Passive Heat Sink to mount on product heat plate.			
VL-HDW-407	Cooling fan for HDW-406 passive heatsink.			
VL-HDW-408	Heat Pipe system to mount on product heat plate.			
Cables				
VL-CBR-0404	4-pin Pico-Clasp / 4-pin IDE Power to 6-pin 12V LED Back Light, .5m			
VL-CBR-1203	ATX 12V (24-pin ATX) to 12-pin Power Adapter Cable 12"			
VL-CBR-1206	12-pin Pico-Clasp / 15-pin VGA, RoHS, 18"			
VL-CBR-1401	14-pin cable assembly for (2) SPX modules, 6"			
VL-CBR-1402	14-pin cable assembly for (4) SPX modules, 12"			
VL-CBR-2031	miniDisplayPort to MiniDisplayPort, 36"			
VL-CBR-2032	miniDisplayPort to VGA adapter, 6"			
VL-CBR-2033	miniDisplayPort to HDMI active adapter, 6"			
VL-CBR-3001	2-Ch LVDS 30-pin JAE to 30-pin JAE, 20"			
VL-CBR-3002	1-Ch LVDS 30-pin JAE to 20-pin Hirose, 20"			
VL-CBR-3003	1-Ch LVDS 30-pin JAE to 20-pin JAE, 20"			
VL-CBR-2034	20-pin (F) ATX to 24-pin (M) ATX adapter cable			
	(use with PS-ATX12-300A), 6"			
Audio				
VL-ADR-01	USB to Audio Adapter			
Solid-State Storage	(flash memory)			
VL-F41-xxxx	microSD card (SDIO), SLC, industrial temp.			
Memory				
VL-MM9-xxEBN	DDR3 PC3-12800 SO-DIMM memory module (1.35v)			
Hardware				
VL-PS200-ATX	Bench-top / development power supply			
VL-PS-ATX12-300A	I X development power supply (requires VL-CBR-2034)			
VL-HDW-106	0.6" standotts, English thread (four per kit)			
VL-HDW-108	Mini PCIe / mSATA hardware kit (metric thread) 2.5 mm			
VL-HDW-112	PC104 (ISA) Spacer			
VL-HDW-113	PC104 (PCI) Spacer			
VL-HDW-115	PC104 (blank) Spacer			
Miscellaneous				
VL-HDW-111	Halt to Full Size Mini PCIe Adapter kit. Metal adapter and screws (2)			
VL-HDW-203	PC/104 extractor tool (metal)			

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Expansion Modules

Part Number	Description	Form Factor				
Network						
VL-MPEe-E4E	Gigabit Ethernet over Fiber adapter	Mini PCle				
VL-MPEe-E3E	Gigabit Ethernet adapter	Mini PCIe				
VL-MPEe-FW1E	FireWire adapter	Mini PCle				
Serial I/O						
VL-MPEe-U2E	Quad serial plus twelve GPIOs	Mini PCIe				
Analog & Digital I/O						
VL-SPX-1	Analog Input Module 8-Channels	SPX				
VL-SPX-2	Digital I/O Module 16-lines	SPX				
VL-SPX-4	Analog Output Module 4-channels 12-bit	SPX				
VL-SPX-5	Solid State Switch Module 8-channel	SPX				
GPS						
VL-MPEu-G2E	GPS receiver	Mini PCIe				
VL-MPEu-G3E	Advanced GPS receiver	Mini PCIe				
Video						
VL-EPM-V7E	Video Expansion Module: VGA and LVDS	PC/104-Plus				
VL-MPEe-V5E	VGA and LVDS Interface	Mini PCIe				
Solid-State Storage (flash memory)						
VL-MPEs-F1Exx	mSATA module (4/16/32 GB) (SATA)	Mini PCIe				
Adapters						
VL-MPEs-S3E	SATA adapter	Mini PCle				
VL-EPM-P2E	PC/104-Plus Mini PCle socket x2 Adapter.	PC/104-Plus				



Mini PCIe Modules

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